

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

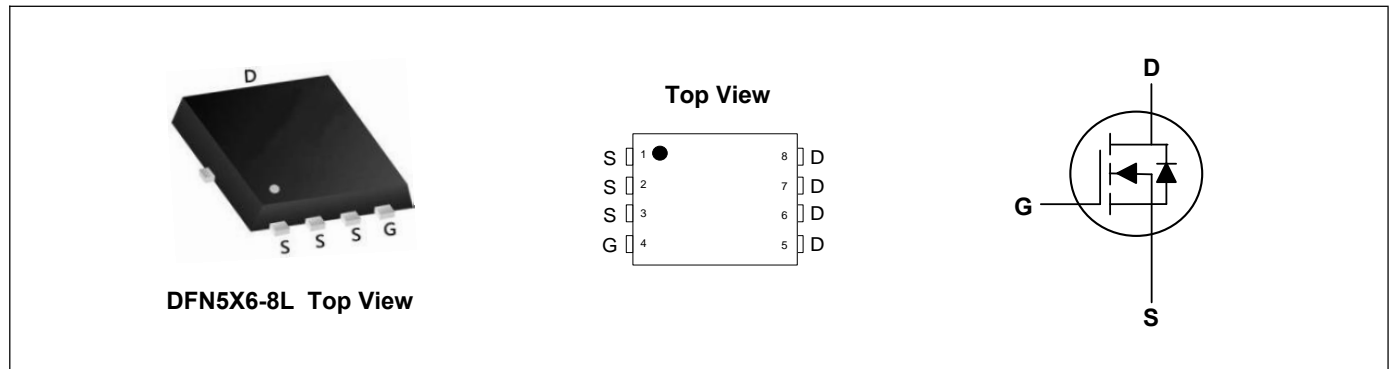
Product Summary



V_{DS}	80	V
I_D	48	A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	6.5	m Ω
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	8.5	m Ω

Applications

- High Frequency Point-of-Load, Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- LCD/LED Back light



Absolute Maximum Ratings ($T_C=25^{\circ}C$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, V_{GS} @ $10V^{1,6}$	$I_D@T_C=25^{\circ}C$	48	A
Continuous Drain Current, V_{GS} @ $10V^{1,6}$	$I_D@T_C=100^{\circ}C$	42.5	A
Pulsed Drain Current ²	I_{DM}	170	A
Single Pulse Avalanche Energy ³	EAS	57.8	mJ
Avalanche Current	I_{AS}	34	A
Total Power Dissipation ⁴	$P_D@T_C=25^{\circ}C$	56	W
Storage Temperature Range	T_{STG}	-55 to 150	$^{\circ}C$
Operating Junction Temperature Range	T_J	-55 to 150	$^{\circ}C$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	---	62	$^{\circ}C/W$
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	2.2	$^{\circ}C/W$

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	80	---	---	V
Static Drain-Source On-Resistance ²	R _{DS(ON)}	V _{GS} =10V, I _D =20A	---	4.3	6.5	mΩ
		V _{GS} =4.5V, I _D =20A	---	6.3	8.5	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250uA	1.2	---	2.3	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =64V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =64V, V _{GS} =0V, T _J =55°C	---	---	5	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA
Forward Transconductance	g _{fs}	V _{DS} =5V, I _D =20A	---	75	---	S
Gate Resistance	R _g	V _{DS} =0V, V _{GS} =0V, f=1MHz	---	0.5	---	Ω
Total Gate Charge (10V)	Q _g	V _{DS} =40V, V _{GS} =10V, I _D =20A	---	40	---	nC
Gate-Source Charge	Q _{gs}		---	7.2	---	
Gate-Drain Charge	Q _{gd}		---	6.5	---	
Turn-On Delay Time	T _{d(on)}	V _{DD} =40V, V _{GS} =10V, R _G =3.3Ω, I _D =20A	---	8.3	---	ns
Rise Time	T _r		---	4.2	---	
Turn-Off Delay Time	T _{d(off)}		---	36	---	
Fall Time	T _f		---	6.9	---	
Input Capacitance	C _{iss}	V _{DS} =40V, V _{GS} =0V, f=1MHz	---	2860	---	pF
Output Capacitance	C _{oss}		---	410	---	
Reverse Transfer Capacitance	C _{rss}		---	38	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current ^{1,5}	I _S	V _G =V _D =0V, Force Current	---	---	48	A
Diode Forward Voltage ²	V _{SD}	V _{GS} =0V, I _S =1A, T _J =25°C	---	0.77	1.0	V
Reverse Recovery Time	t _{rr}	I _F =20A, di/dt=100A/μs, T _J =25°C	---	27	---	nS
Reverse Recovery Charge	Q _{rr}		---	89	---	nC

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%
- 3.The EAS data shows Max. rating. The test condition is V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=34A
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.
- 6.The maximum current rating is package limited.

Typical Characteristics

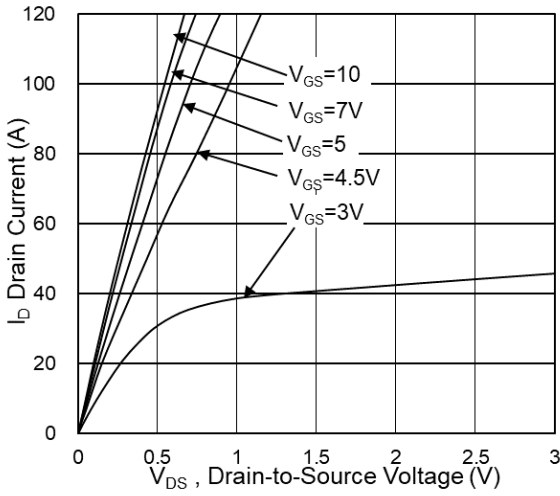


Fig.1 Typical Output Characteristics

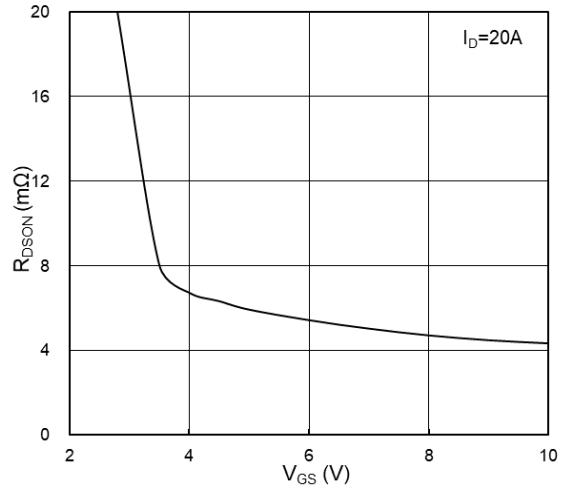


Fig.2 On-Resistance vs G-S Voltage

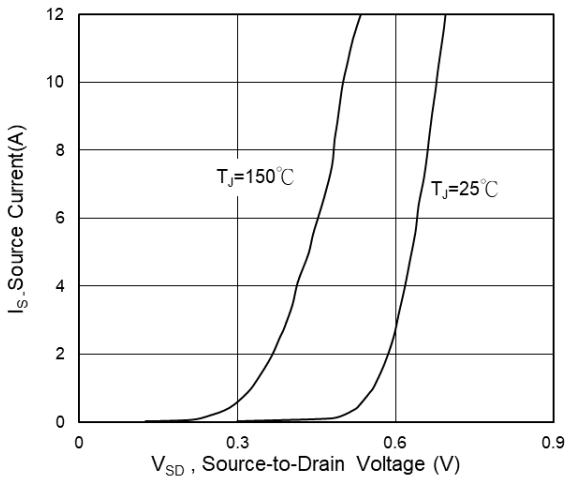


Fig.3 Source Drain Forward Characteristics

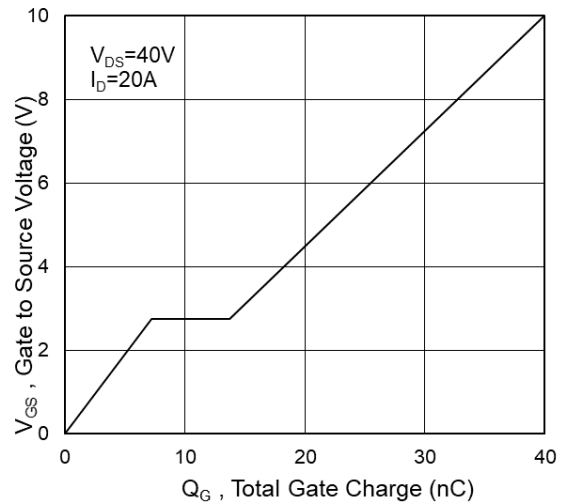


Fig.4 Gate-Charge Characteristics

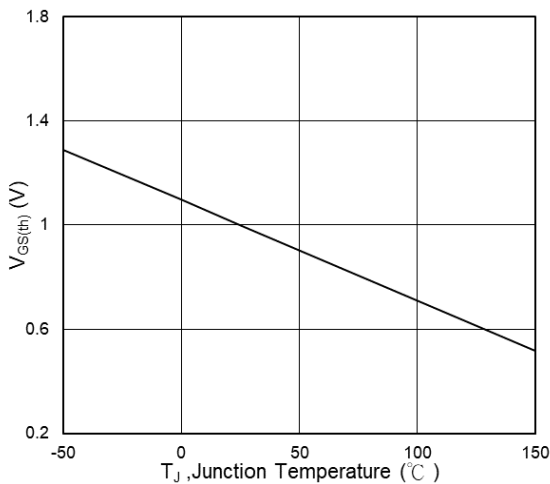


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

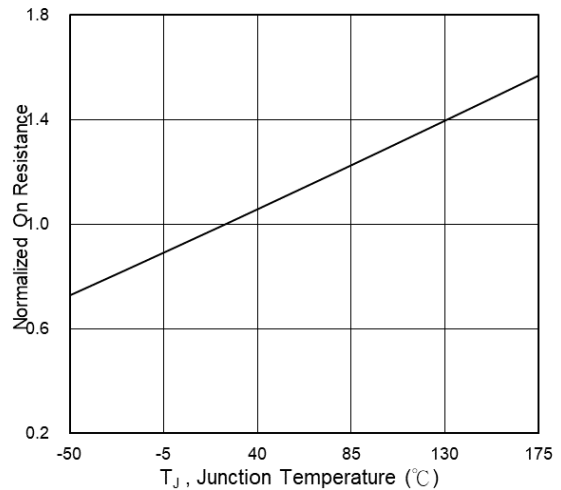


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

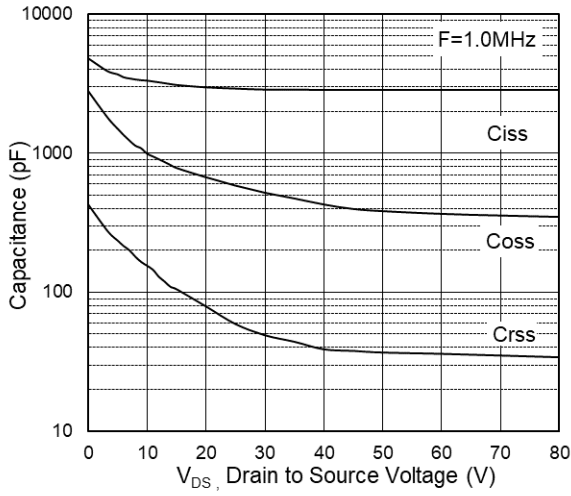


Fig.7 Capacitance

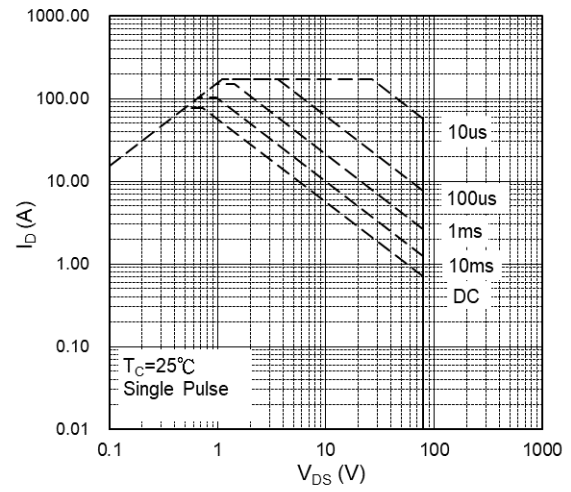


Fig.8 Safe Operating Area

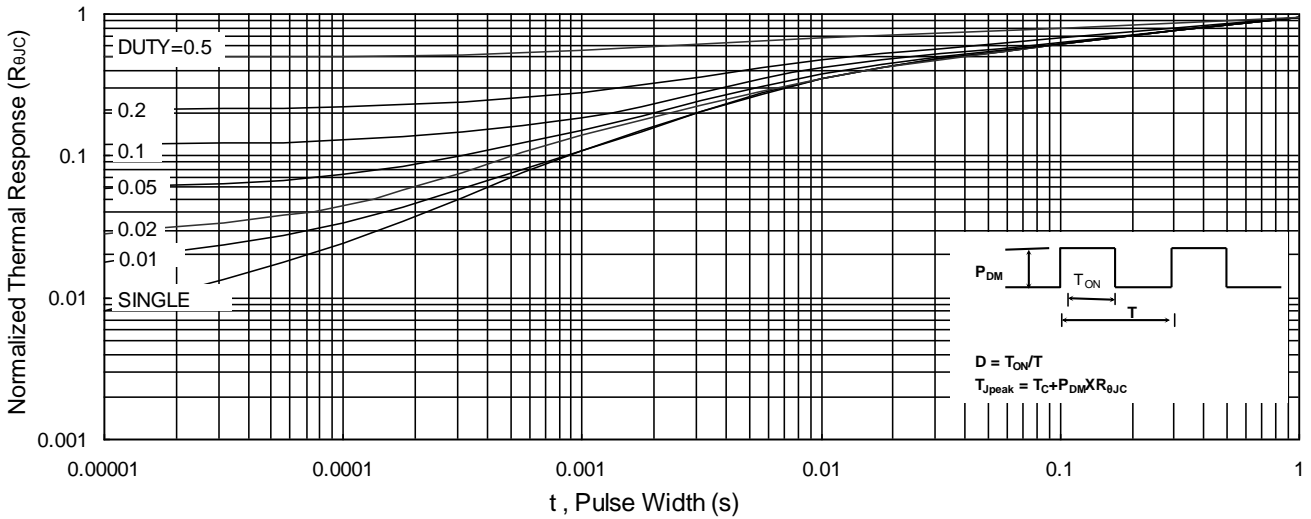


Fig.9 Normalized Maximum Transient Thermal Impedance

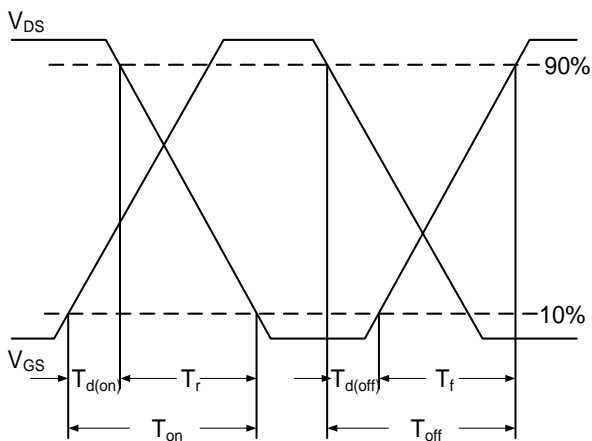


Fig.10 Switching Time Waveform

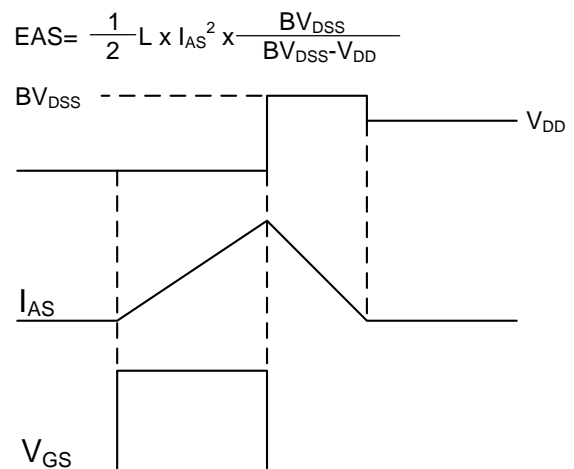
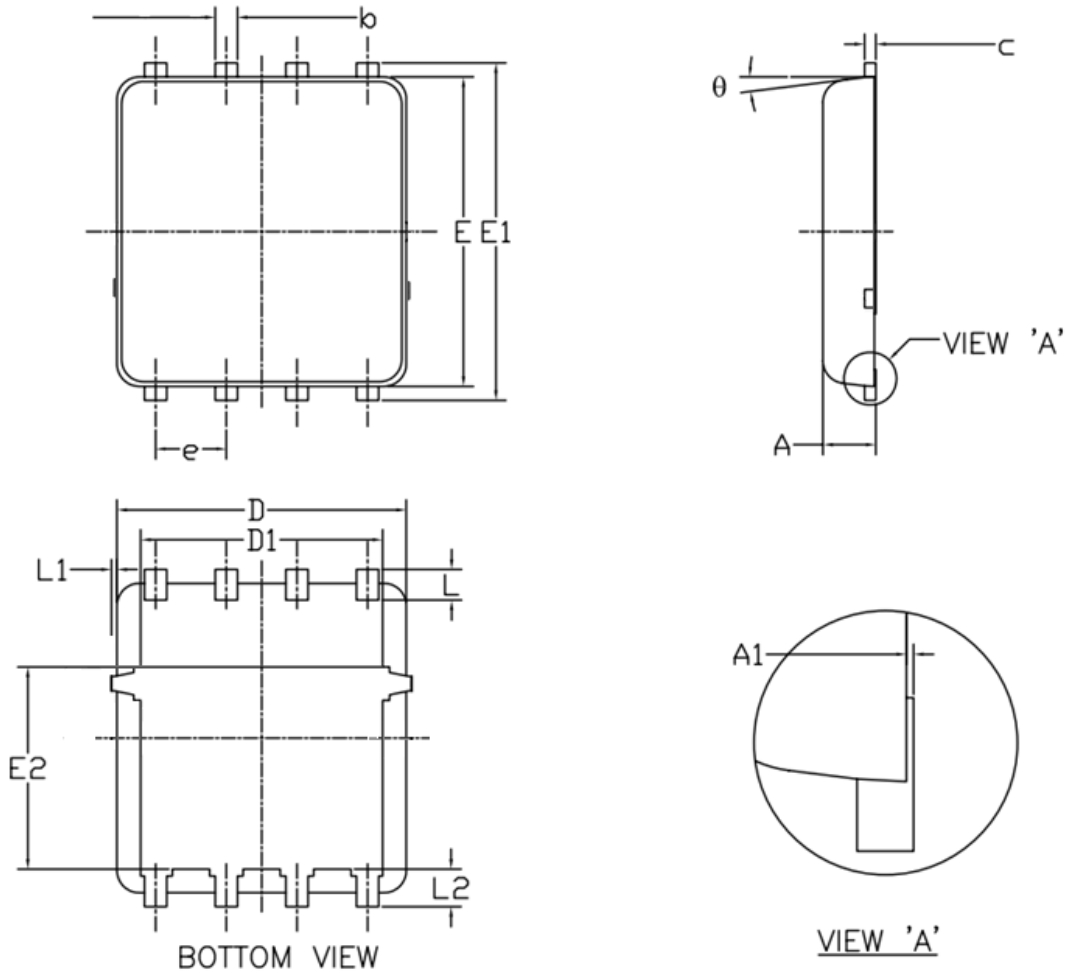


Fig.11 Unclamped Inductive Switching Waveform

DFN5X6-8L Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	0.90	1.00	1.20	E1	5.90	6.10	6.35
A1	0.00	--	0.05	E2	3.38	3.58	3.92
b	0.30	0.40	0.51	e	1.27 BSC		
c	0.20	0.25	0.33	L	0.51	0.61	0.71
D	4.80	4.90	5.40	L1	--	--	0.15
D1	3.61	4.00	4.25	L2	0.41	0.51	0.61
E	5.65	5.80	6.06	θ	0°	--	12°